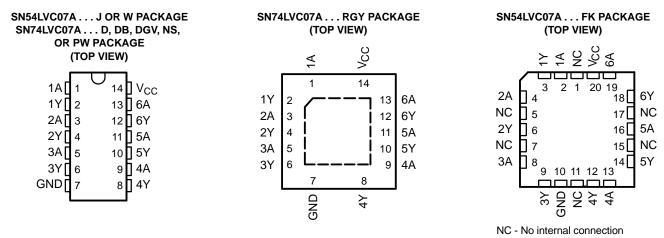


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### FEATURES

- Operate From 1.65 V to 5 V
- Inputs and Open-Drain Outputs Accept Voltages up to 5.5 V
- Max t<sub>pd</sub> of 2.6 ns at 5 V
- Latch-Up Performance Exceeds 250 mA Per JESD 17



## **DESCRIPTION/ORDERING INFORMATION**

These hex buffers/drivers are designed for 1.65-V to 5.5-V  $V_{CC}$  operation.

The outputs of the 'LVC07A devices are open drain and can be connected to other open-drain outputs to implement active-low wired-OR or active-high wired-AND functions. The maximum sink current is 24 mA.

Inputs can be driven from 1.8-V, 2.5-V, 3.3-V (LVTTL), or 5-V (CMOS) devices. This feature allows the use of these devices as translators in a mixed-system environment.

#### **ORDERING INFORMATION**

T <sub>A</sub>	PA	CKAGE <sup>(1)</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
	QFN – RGY	Reel of 1000	SN74LVC07ARGYR	LC07A	
		Tube of 50	SN74LVC07AD		
	SOIC – D	Reel of 2500	SN74LVC07ADR	LVC07A	
		Reel of 250	SN74LVC07ADT		
10°C to 95°C	SOP – NS	Reel of 2000	SN74LVC07ANSR	LVC07A	
–40°C to 85°C	SSOP – DB	Reel of 2000	SN74LVC07ADBR	LC07A	
		Tube of 90	SN74LVC07APW	LC07A	
	TSSOP – PW	Reel of 2000	SN74LVC07APWR		
		Reel of 250	SN74LVC07APWT		
	TVSOP – DGV	Reel of 2000	SN74LVC07ADGVR	LC07A	
	CDIP – J	Tube of 25	SNJ54LVC07AJ	SNJ54LVC07AJ	
-55°C to 125°C	CFP – W	Tube of 150	SNJ54LVC07AW	SNJ54LVC07AW	
	LCCC – FK	Tube of 55	SNJ54LVC07AFK	SNJ54LVC07AFK	

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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### **FUNCTION TABLE** (EACH BUFFER/DRIVER)

INPUT A	OUTPUT Y
Н	Н
L	L

### LOGIC DIAGRAM, EACH BUFFER/DRIVER (POSITIVE LOGIC)



## Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage range		-0.5	6.5	V
VI	Input voltage range <sup>(2)</sup>		-0.5	6.5	V
Vo	Output voltage range		-0.5	6.5	V
I <sub>IK</sub>	Input clamp current	V <sub>1</sub> < 0		-50	mA
I <sub>OK</sub>	Output clamp current	V <sub>O</sub> < 0		-50	mA
I <sub>O</sub>	Continuous output current	·		±50	mA
	Continuous current through V <sub>CC</sub> or GND			±100	mA
		D package <sup>(3)</sup>		86	
		DB package <sup>(3)</sup>		96	
0	Dealer we the second increased	DGV package <sup>(3)</sup>		127	0000
$\theta_{JA}$	Package thermal impedance	NS package <sup>(3)</sup>		76	°C/W
		PW package <sup>(3)</sup>		113	
		RGY package <sup>(4)</sup>		47	
T <sub>stg</sub>	Storage temperature range	· · · · ·	-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
(3) The package thermal impedance is calculated in accordance with JESD 51-7.

(4) The package thermal impedance is calculated in accordance with JESD 51-5.

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# Recommended Operating Conditions<sup>(1)</sup>

			SN54LV	SN54LVC07A <sup>(2)</sup>		VC07A	LINUT	
			MIN	MAX	MIN	MAX	UNIT	
V <sub>CC</sub>	Supply voltage		1.65	5.5	1.65	5.5	V	
		V <sub>CC</sub> = 1.65 V to 1.95 V	$0.65 \times V_{CC}$		$0.65 \times V_{CC}$			
V		$V_{CC}$ = 2.3 V to 2.7 V	1.7		1.7		V	
VIH	High-level input voltage	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2		2		V	
	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	$0.7 \times V_{CC}$		$0.7  imes V_{CC}$				
		V <sub>CC</sub> = 1.65 V to 1.95 V		$0.35 \times V_{\text{CC}}$		$0.35\times V_{CC}$		
		$V_{CC}$ = 2.3 V to 2.7 V		0.7		0.7	V	
V <sub>IL</sub>	Low-level input voltage	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		0.8		0.8	V	
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		$0.3  imes V_{CC}$		$0.3  imes V_{CC}$		
VI	Input voltage	i.	0	5.5	0	5.5	V	
Vo	Output voltage		0	5.5	0	5.5	V	
		V <sub>CC</sub> = 1.65 V		4		4		
		V <sub>CC</sub> = 2.3 V		12		12		
I <sub>OL</sub>	Low-level output current	V <sub>CC</sub> = 2.7 V		12		12	mA	
		$V_{CC} = 3 V$		24		24		
		V <sub>CC</sub> = 4.5 V		24		24		
T <sub>A</sub>	Operating free-air temperature	·	-55	125	-40	85	°C	

(1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

Product preview (2)

### **Electrical Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIONS	V	SN54LVC07A <sup>(1)</sup>	SN74LVC07A	UNIT			
PARAMETER	TEST CONDITIONS	V <sub>cc</sub>	MIN TYP <sup>(2)</sup> MAX	MIN TYP <sup>(2)</sup> MAX				
	I <sub>OL</sub> = 100 μA	1.65 V to 5.5 V	0.2	0.2				
	I <sub>OL</sub> = 4 mA	1.65 V	0.45	0.45				
	1. 12	2.3 V	0.7	0.7	V			
V <sub>OL</sub>	I <sub>OL</sub> = 12 mA	2.7 V	0.4	0.4	V			
	1 24	3 V	0.55	0.55				
	$I_{OL} = 24 \text{ mA}$	4.5 V						
l <sub>l</sub>	$V_1 = 5.5 V \text{ or GND}$	3.6 V	±5	±5	μA			
I <sub>CC</sub>	$V_{I} = V_{CC} \text{ or GND}, \qquad I_{O} = 0$	3.6 V	10	10	μA			
ΔI <sub>CC</sub>	One input at $V_{CC}$ – 0.6 V, Other inputs at $V_{CC}$ or GND	2.7 V to 3.6 V	500	500	μΑ			
C <sub>i</sub>	$V_{I} = V_{CC}$ or GND	3.3 V	5	5	pF			

(1)

Product preview All typical values are at V\_{CC} = 3.3 V, T\_A = 25^{\circ}C. (2)



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#### **Switching Characteristics**

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1 through Figure 4)

FROM     TO     V <sub>CC</sub> = 1.8 V     V <sub>CC</sub> = 2.5 V     V <sub>CC</sub> = 3.3 V     V <sub>CC</sub> = 5													
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = ± 0.1		V <sub>CC</sub> = ± 0.2		V <sub>CC</sub> =	2.7 V	V <sub>CC</sub> = ± 0.3	3.3 V 3 V	= V <sub>CC</sub> ± 0.		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub>	А	Y	1	3.5	1	2.8		3	1	2.9	1	2.6	ns

(1) Product preview

### **Switching Characteristics**

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1 through Figure 4)

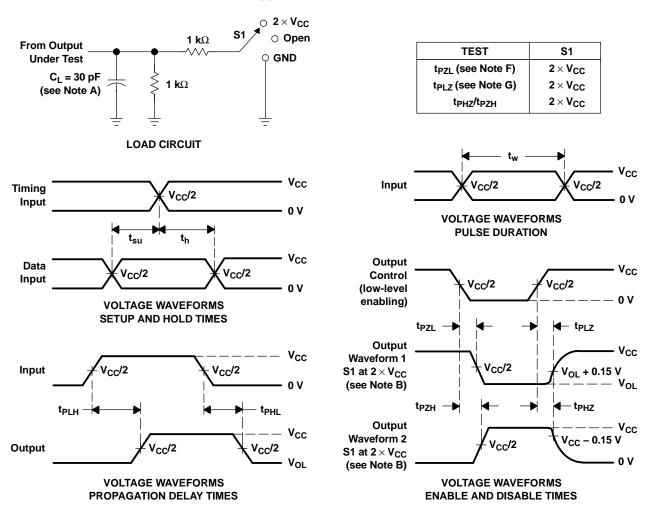
				SN74LVC07A									
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = ± 0.1		V <sub>CC</sub> = ± 0.2		V <sub>CC</sub> =	2.7 V	V <sub>CC</sub> = ± 0.3		= V <sub>CC</sub> ± 0.5		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub>	А	Y	1	3.5	1	2.8		3	1	2.9	1	2.6	ns

### **Operating Characteristics**

 $T_A = 25^{\circ}C$ 

	PARAMETER	TEST CONDITIONS	V <sub>CC</sub> = 1.8 V TYP	V <sub>CC</sub> = 2.5 V TYP	V <sub>CC</sub> = 3.3 V TYP	V <sub>CC</sub> = 5 V TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance per buffer/driver	f = 10 MHz	1.8	2	2.5	3.78	pF

PARAMETER MEASUREMENT INFORMATION  $V_{cc}$  = 1.8 V  $\pm$  0.15 V

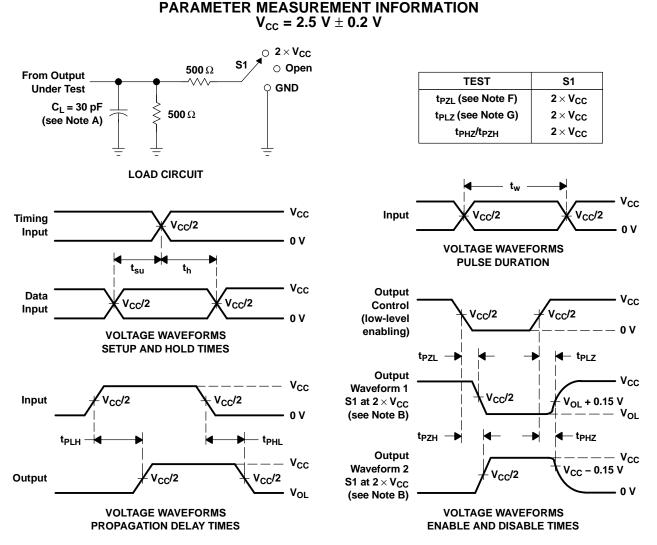


NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>r</sub>  $\leq$  2 ns, t<sub>f</sub>  $\leq$  2 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. Since this device has open-drain outputs,  $t_{PLZ}$  and  $t_{PZL}$  are the same as  $t_{od}$ .
- F.  $t_{PZL}$  is measured at  $V_{CC}/2$ .
- G.  $t_{PLZ}$  is measured at  $V_{OL}$  + 0.15 V.
- H. All parameters and waveforms are not applicable to all devices.

#### Figure 1. Load Circuit and Voltage Waveforms

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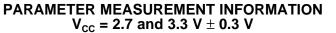
STRUMENTS www.ti.com

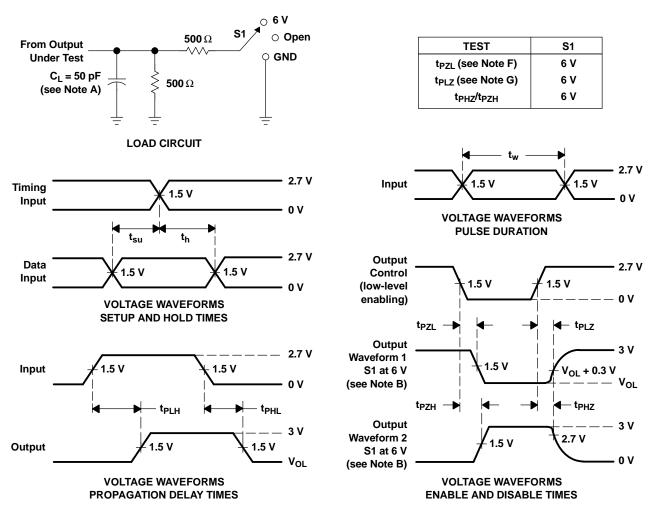
NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics:  $PRR \le 10$  MHz,  $Z_0 = 50 \Omega$ ,  $t_r \le 2$  ns,  $t_f \le 2$  ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. Since this device has open-drain outputs,  $t_{PLZ}$  and  $t_{PZL}$  are the same as  $t_{pd}$ .
- F.  $t_{PZL}$  is measured at  $V_{CC}/2$ .
- G.  $t_{PLZ}$  is measured at  $V_{OL}$  + 0.15 V.
- H. All parameters and waveforms are not applicable to all devices.

#### Figure 2. Load Circuit and Voltage Waveforms

SCAS595O-OCTOBER 1997-REVISED JULY 2005



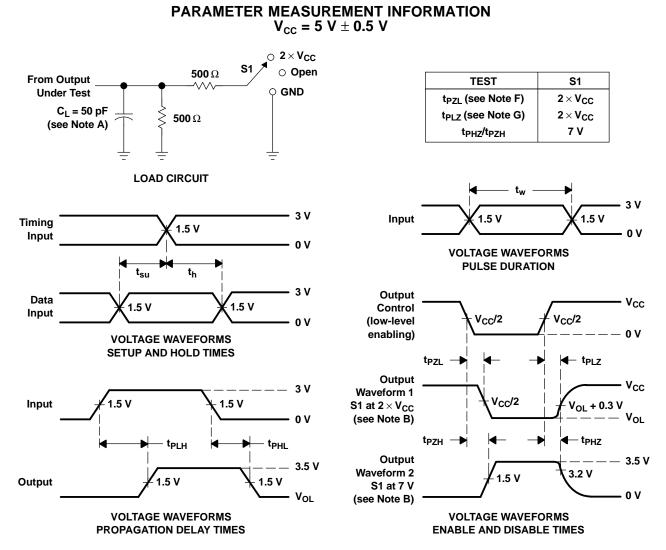


NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control.
- Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>0</sub> = 50  $\Omega$ , t<sub>r</sub>  $\leq$  2.5 ns, t<sub>f</sub>  $\leq$  2.5 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. Since this device has open-drain outputs,  $t_{PLZ}$  and  $t_{PZL}$  are the same as  $t_{pd}$ .
- F. t<sub>PZL</sub> is measured at 1.5 V.
- G.  $t_{PLZ}$  is measured at V<sub>OL</sub> + 0.3 V.
- H. All parameters and waveforms are not applicable to all devices.

#### Figure 3. Load Circuit and Voltage Waveforms

SCAS595O-OCTOBER 1997-REVISED JULY 2005



7 Texas istruments

www.ti.com

NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control.
- Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>r</sub>  $\leq$  2.5 ns, t<sub>f</sub>  $\leq$  2.5 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. Since this device has open-drain outputs,  $t_{PLZ}$  and  $t_{PZL}$  are the same as  $t_{pd}$ .
- F.  $t_{PZL}$  is measured at  $V_{CC}/2$ .
- G.  $t_{PLZ}$  is measured at  $V_{OL}$  + 0.3 V.
- H. All parameters and waveforms are not applicable to all devices.

#### Figure 4. Load Circuit and Voltage Waveforms

9-Aug-2005

### **PACKAGING INFORMATION**

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Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN74LVC07AD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07ADBR	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07ADBRG4	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07ADE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07ADGVR	ACTIVE	TVSOP	DGV	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07ADGVRE4	ACTIVE	TVSOP	DGV	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07ADGVRG4	ACTIVE	TVSOP	DGV	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07ADR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07ADRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07ADRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07ADT	ACTIVE	SOIC	D	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07ADTE4	ACTIVE	SOIC	D	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07ANSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07ANSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07APW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07APWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07APWLE	OBSOLETE	TSSOP	PW	14		TBD	Call TI	Call TI
SN74LVC07APWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07APWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07APWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07APWT	ACTIVE	TSSOP	PW	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07APWTE4	ACTIVE	TSSOP	PW	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07APWTG4	ACTIVE	TSSOP	PW	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC07ARGYR	ACTIVE	QFN	RGY	14	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1YEAR

<sup>(1)</sup> The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.



LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available. **OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

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<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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PLASTIC SMALL-OUTLINE

MPDS006C - FEBRUARY 1996 - REVISED AUGUST 2000

### DGV (R-PDSO-G\*\*)

24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153

14/16/20/56 Pins – MO-194



D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



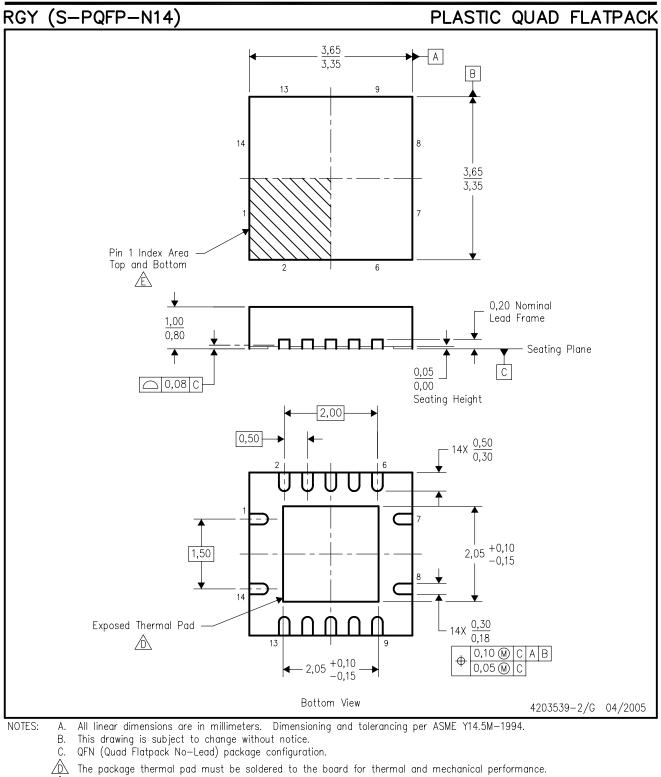
NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012 variation AB.





È Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated. The Pin 1 identifiers are either a molded, marked, or metal feature.

F. Package complies to JEDEC MO-241 variation BA.



### PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

## DB (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

# PW (R-PDSO-G\*\*)

### PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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